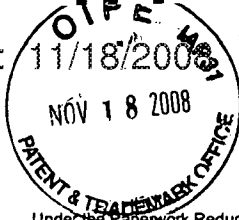


Receipt date: 11/18/2008

10670365 - GAU: 2627



PTO/SB/08b (08-08)

Approved for use through 09/30/2008. OMB 0651-0031  
U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

|  |                        |                          |                        |
|--|------------------------|--------------------------|------------------------|
| Substitute for form 1449/PTO   |                        | <b>Complete If Known</b> |                        |
| <b>INFORMATION DISCLOSURE<br/>STATEMENT BY APPLICANT</b><br><br><i>(Use as many sheets as necessary)</i> |                        | Application Number       | 10/670,365-Conf. #6887 |
|  |                        | Filing Date              | September 26, 2003     |
|  |                        | First Named Inventor     | Yong Cheol PARK        |
|  |                        | Art Unit                 | 2627                   |
|  |                        | Examiner Name            | L. Chow                |
| Sheet 1 of 1   | Attorney Docket Number | 0465-1028P               |                        |

| U.S. PATENT DOCUMENTS |                       |   |                                |  |   |
|-----------------------|-----------------------|---|--------------------------------|--|---|
| Examiner Initials*    | Cite No. <sup>1</sup> | Document Number<br>Number-Kind Code <sup>2</sup> (if known) | Publication Date<br>MM-DD-YYYY | Name of Patentee or<br>Applicant of Cited Document | Pages, Columns, Lines, Where<br>Relevant Passages or Relevant<br>Figures Appear |
|                       | AA*                   | US-20050047294  | 03-03-2005                     | Park   |   |
|                       | AB*                   | US-6,373,800  | 04-16-2002                     | Takahashi et al.                                   |   |
|                       | AC*                   | US-6,788,631  | 09-07-2004                     | Park et al.  |   |
|                       | AD*                   | US-7,123,556  | 10-17-2006                     | Ueda et al.  |   |
|                       | AE*                   | US-7,313,066  | 12-25-2007                     | Hwang et al.                                       |   |
|                       | AF*                   | US-5,068,842  | 11-26-1991                     | Naito et al.                                       |   |
|                       | AG*                   | US-6,466,532  | 10-15-2002                     | Ko et al.  |   |
|                       | AH*                   | US-6,493,301  | 12-10-2002                     | Park et al.  |   |
|                       | AI*                   | US-6,542,450-B1   | 04-01-2003                     | Park et al.  |   |
|                       | AJ*                   | US-6,714,502  | 03-30-2004                     | Ko et al.  |   |
|                       | AK*                   | US-20050050402  | 03-03-2005                     | Koda et al.  |   |

| FOREIGN PATENT DOCUMENTS |                       |  |                                |  |  |
|--------------------------|-----------------------|--|--------------------------------|--|--|
| Examiner Initials*       | Cite No. <sup>1</sup> | Foreign Patent Document<br>Country Code <sup>3</sup> -Number <sup>4</sup> -Kind Code <sup>5</sup> (if known) | Publication Date<br>MM-DD-YYYY | Name of Patentee or<br>Applicant of Cited Document | Pages, Columns, Lines, Where<br>Relevant Passages Or Relevant Figures Appear |
|                          | BA                    | WO-2005/004154-A2  | 01-13-2005                     |  |  |
|                          | BB                    | EP-1612790-A1  | 01-04-2006                     |  |  |
|                          | BC                    | WO-2004/079731-A1  | 09-16-2004                     |  |  |
|                          | BD                    | EP-0908882-A2  | 04-14-1999                     |  |  |

| NON PATENT LITERATURE DOCUMENTS |                       |   |                |
|---------------------------------|-----------------------|---|----------------|
| Examiner Initials               | Cite No. <sup>1</sup> | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | T <sup>2</sup> |
|                                 |                       |   |                |
|                                 |                       |   |                |
|                                 |                       |   |                |
|                                 |                       |   |                |
|                                 |                       |   |                |
|                                 |                       |   |                |

|                    |             |                 |            |
|--------------------|-------------|-----------------|------------|
| Examiner Signature | /Lixi Chow/ | Date Considered | 12/18/2008 |
|--------------------|-------------|-----------------|------------|

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. \* CITE NO.: Those application(s) which are marked with an single asterisk (\*) next to the Cite No. are not supplied (under 37 CFR 1.98(a)(2)(iii)) because that application was filed after June 30, 2003 or is available in the IFW. <sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kinds Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

ALL REFERENCES CONSIDERED EXCEPT WHERE LINED THROUGH. /L.C./